



US009281813B2

(12) **United States Patent**
Ivankovic

(10) **Patent No.:** **US 9,281,813 B2**
(45) **Date of Patent:** ***Mar. 8, 2016**

(54) **HALF BRIDGE FLYBACK AND FORWARD**

USPC 327/419, 427-434
See application file for complete search history.

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(*) Notice: Subject to any disclaimer, the term of this
patent is extended or adjusted under 35
U.S.C. 154(b) by 0 days.

This patent is subject to a terminal dis-
claimer.

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(21) Appl. No.: **14/150,081**

(22) Filed: **Jan. 8, 2014**

(65) **Prior Publication Data**

US 2014/0118057 A1 May 1, 2014

Related U.S. Application Data

(63) Continuation of application No. 13/436,109, filed on
Mar. 30, 2012, now Pat. No. 8,653,881, which is a
continuation-in-part of application No. 13/362,100,
filed on Jan. 31, 2012, now Pat. No. 8,779,841.

(51) **Int. Cl.**
H03K 17/687 (2006.01)
H03K 17/10 (2006.01)

(Continued)

(52) **U.S. Cl.**
CPC **H03K 17/687** (2013.01); **H02M 1/088**
(2013.01); **H02M 3/3353** (2013.01);
(Continued)

(58) **Field of Classification Search**
CPC H03K 17/04123; H03K 17/063; H03K
17/168; H03K 17/687; H03K 17/0822

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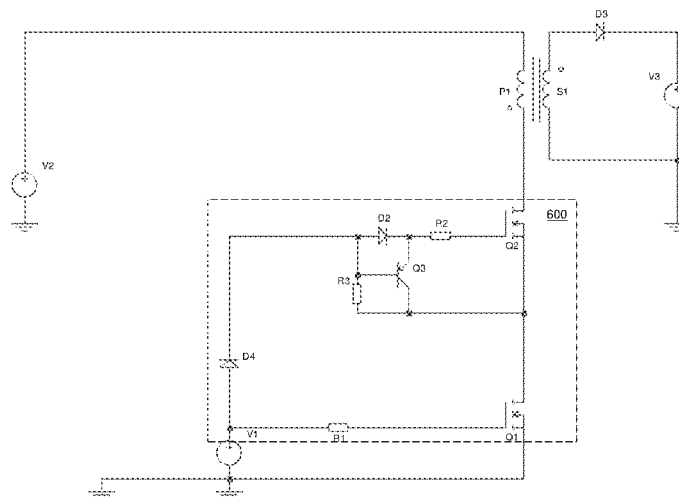
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PLLC

(57) **ABSTRACT**

A circuit includes a transformer having a first winding and a
second winding, an input connected to a first terminal of the
first winding, a first power transistor and a second power
transistor. The first power transistor has a source, a gate, and
a drain connected to a second terminal of the first winding.
The second power transistor has a source connected to
ground, a gate connected to a pulsed voltage drive source and
a drain connected to the source of the first power transistor.
The gate of the first power transistor is connected to a DC
source or the same pulsed voltage drive source as the gate of
the second power transistor. The first power transistor actively
turns off independent of load current. Other circuit embodi-
ments and corresponding load switching methods are also
provided.

11 Claims, 13 Drawing Sheets



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- (51) **Int. Cl.**
H03K 17/74 (2006.01)
H02M 1/088 (2006.01)
H02M 3/335 (2006.01)
- (52) **U.S. Cl.**
 CPC *H03K 17/102* (2013.01); *H03K 17/74*
 (2013.01); *H02M 3/335* (2013.01); *H02M*
3/33538 (2013.01); *Y10T 307/50* (2015.04)
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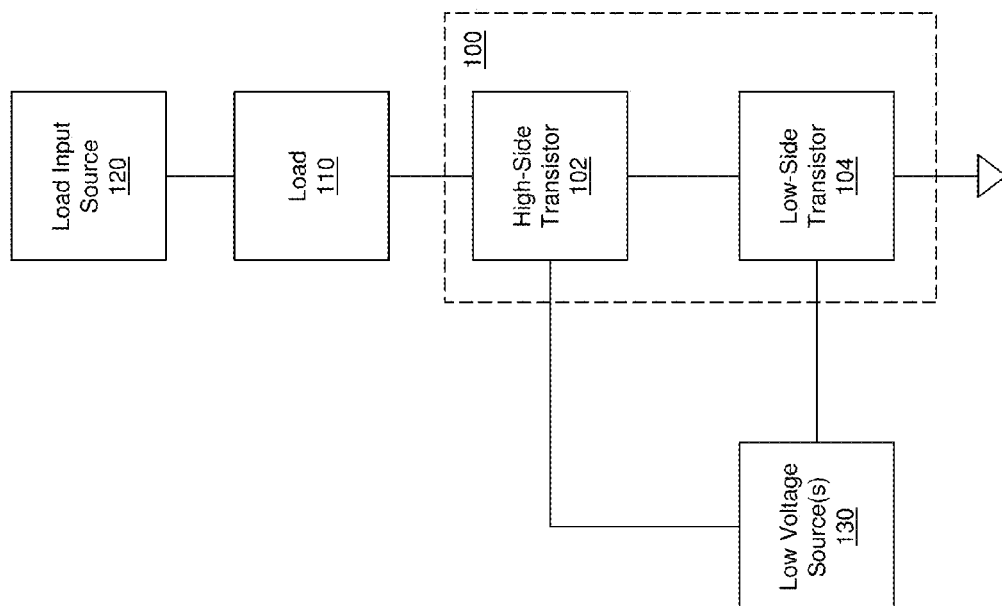


Figure 1

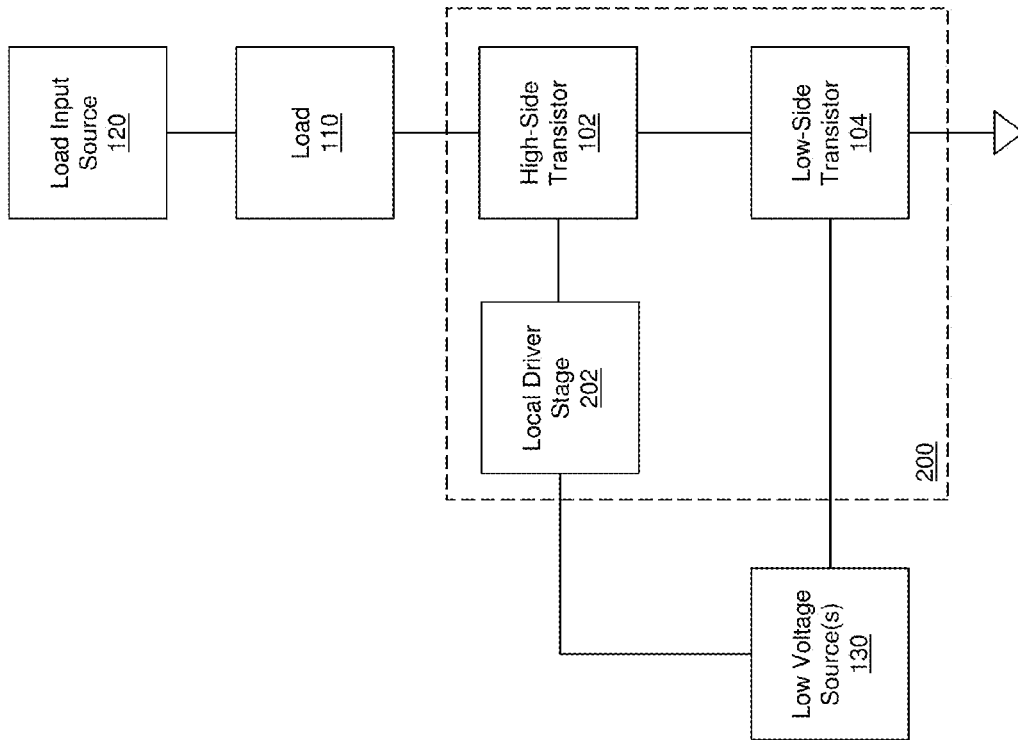


Figure 2

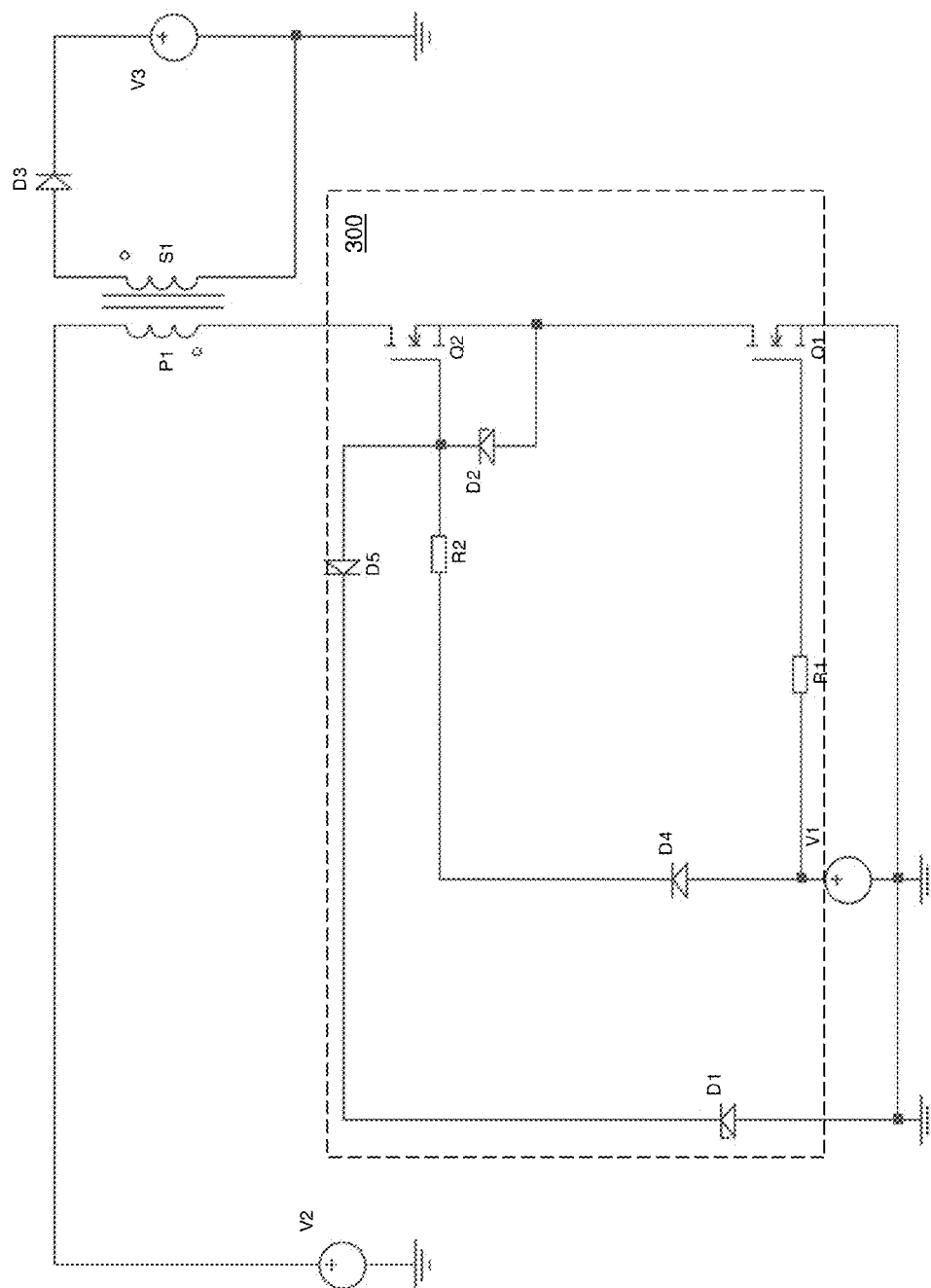


Figure 3

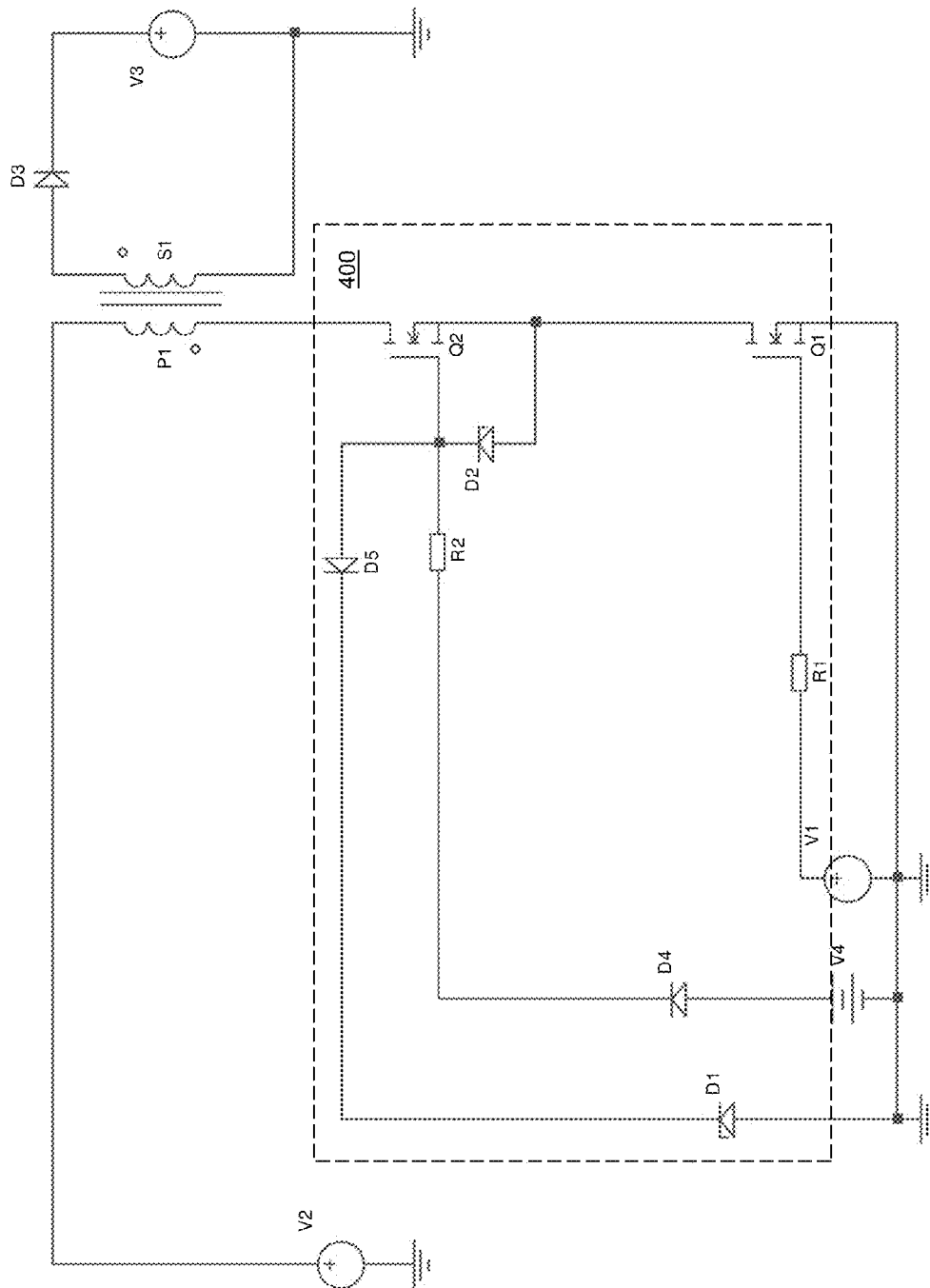


Figure 4

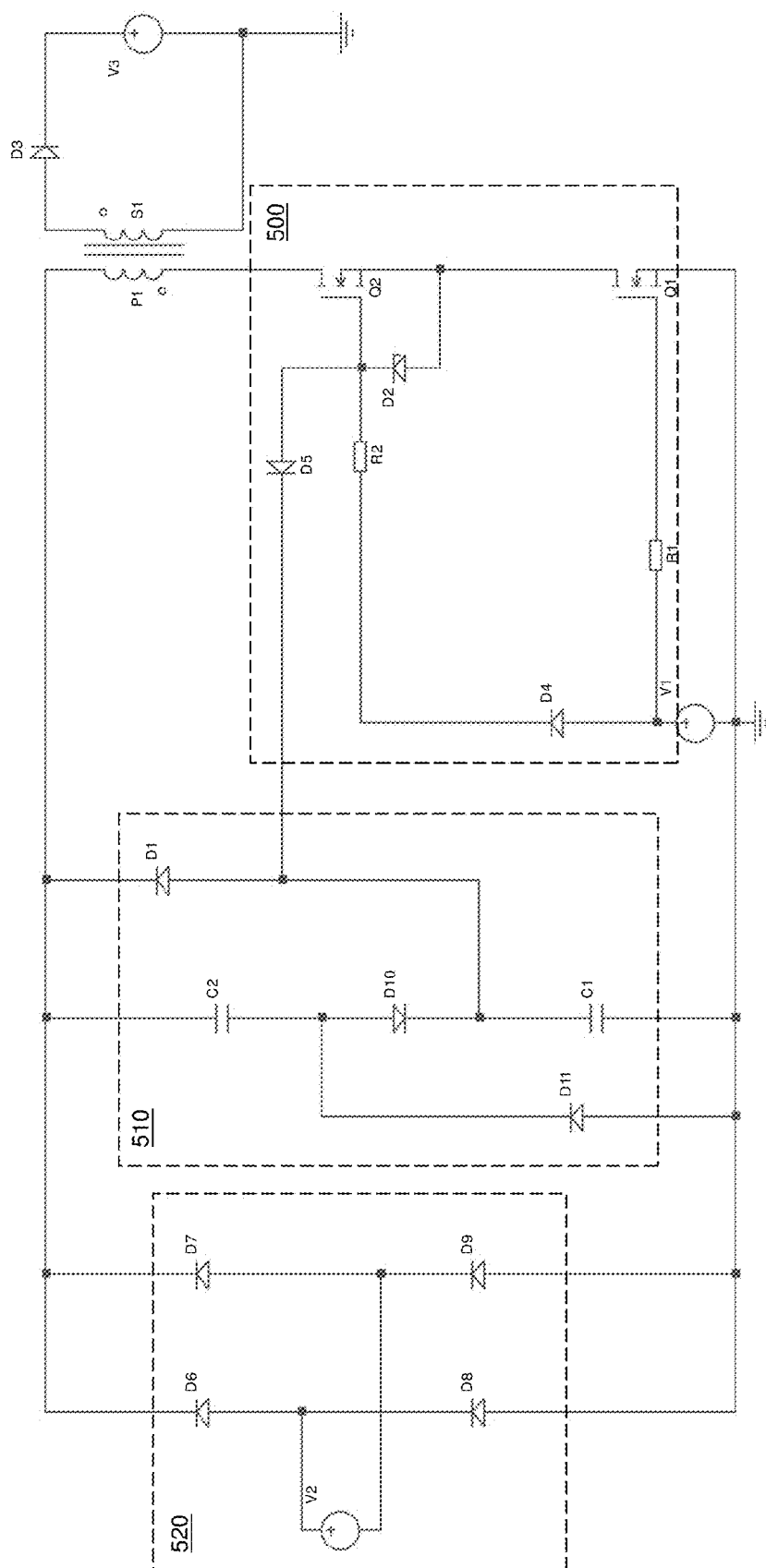


Figure 5

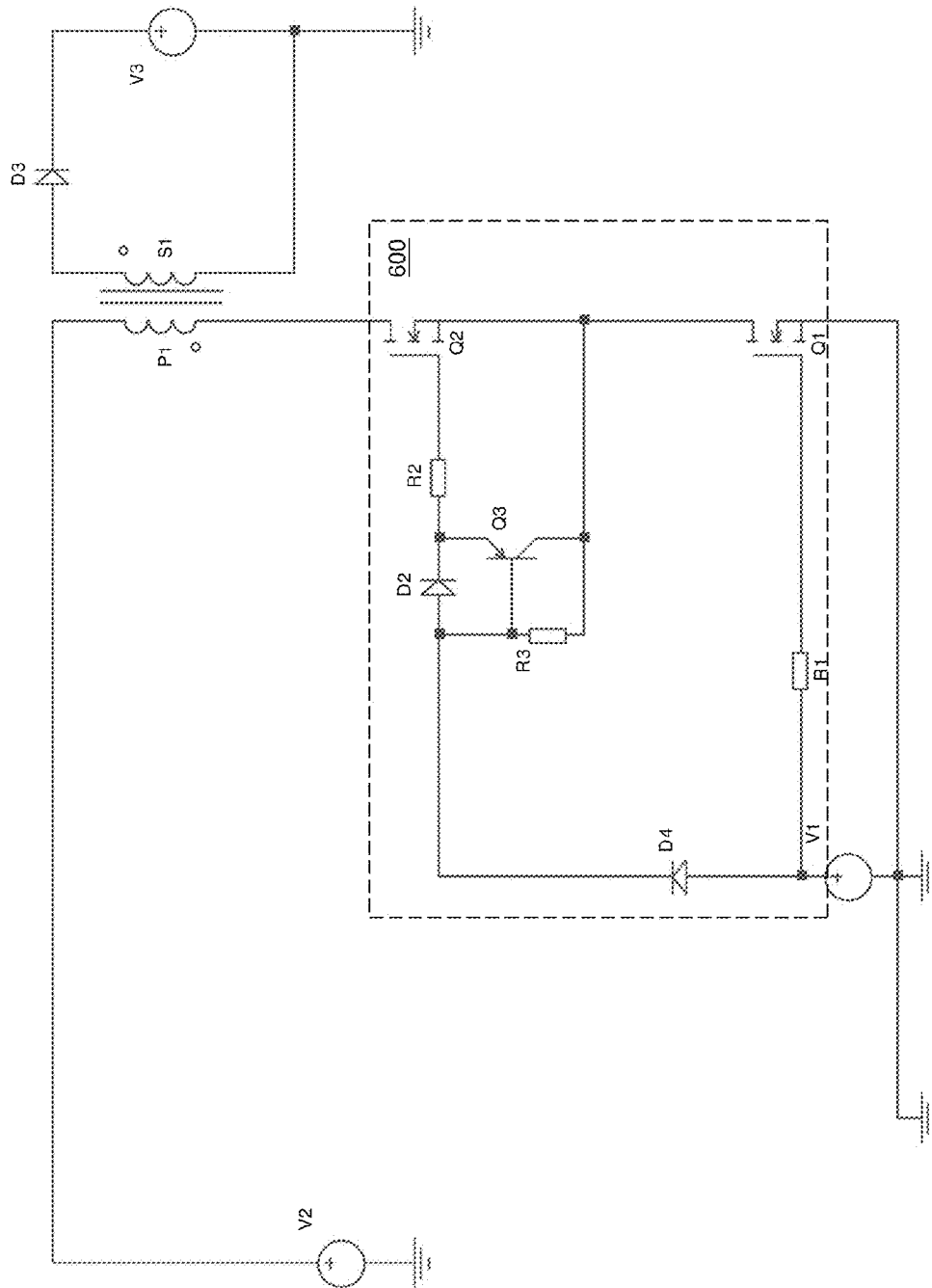


Figure 6

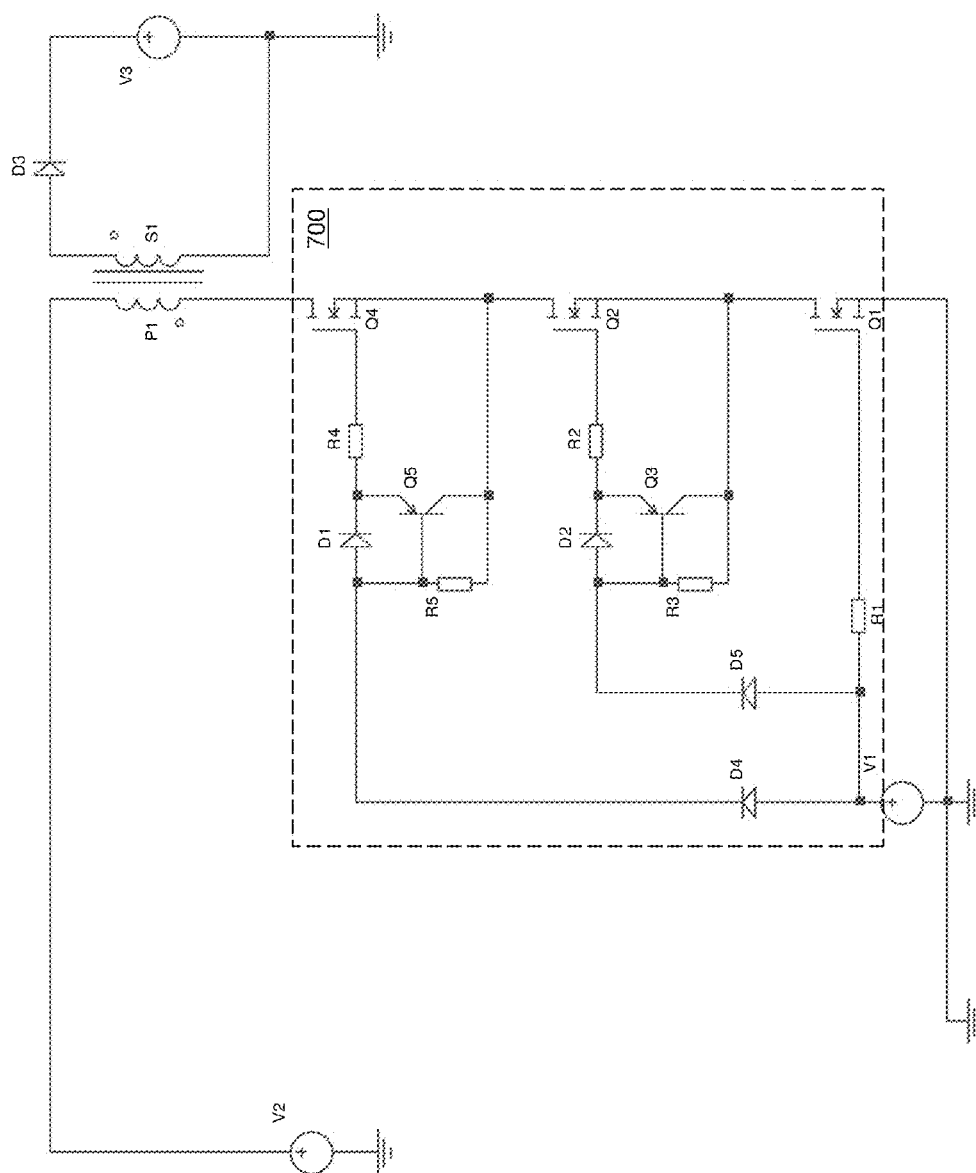


Figure 7

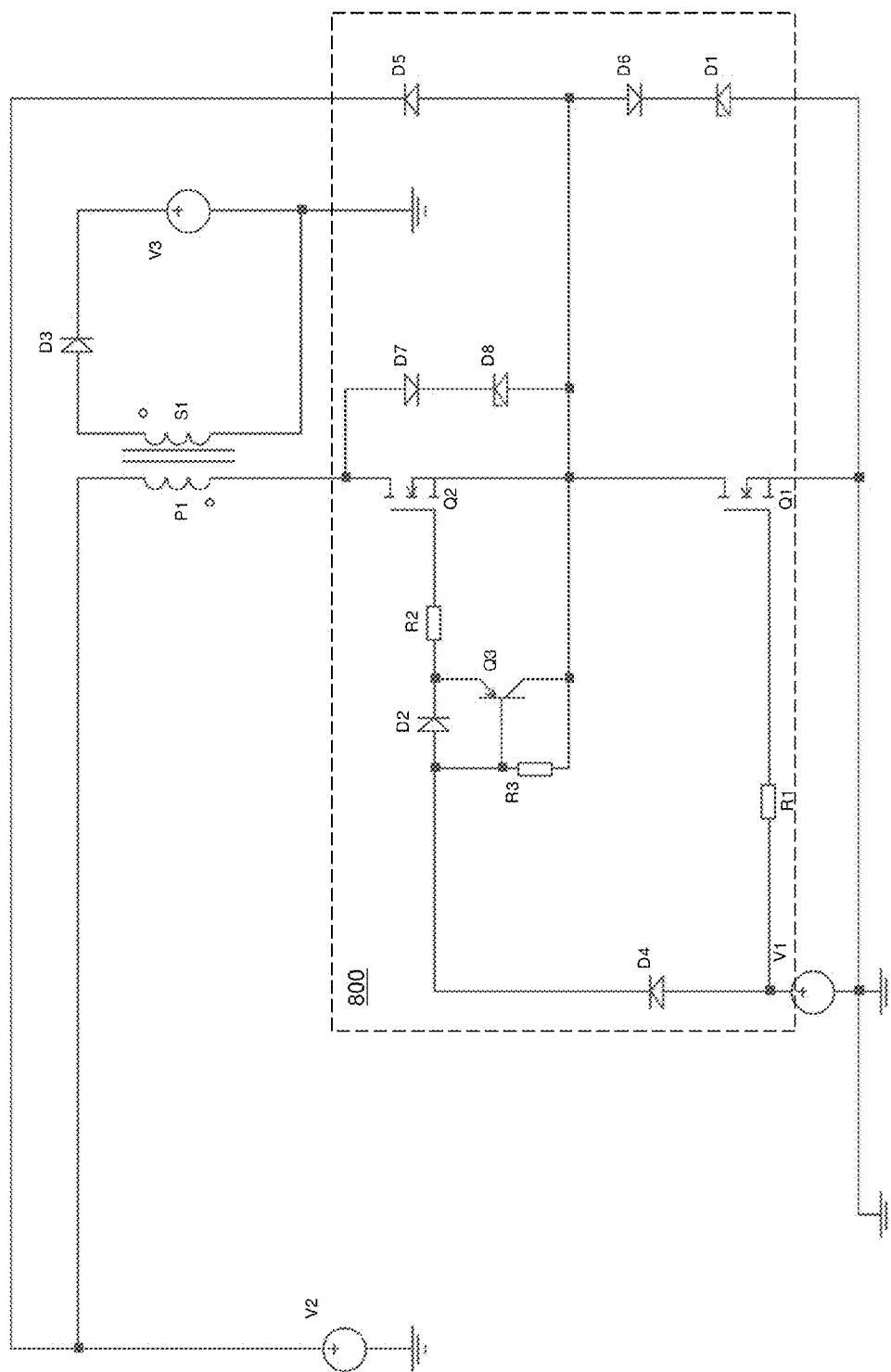


Figure 8

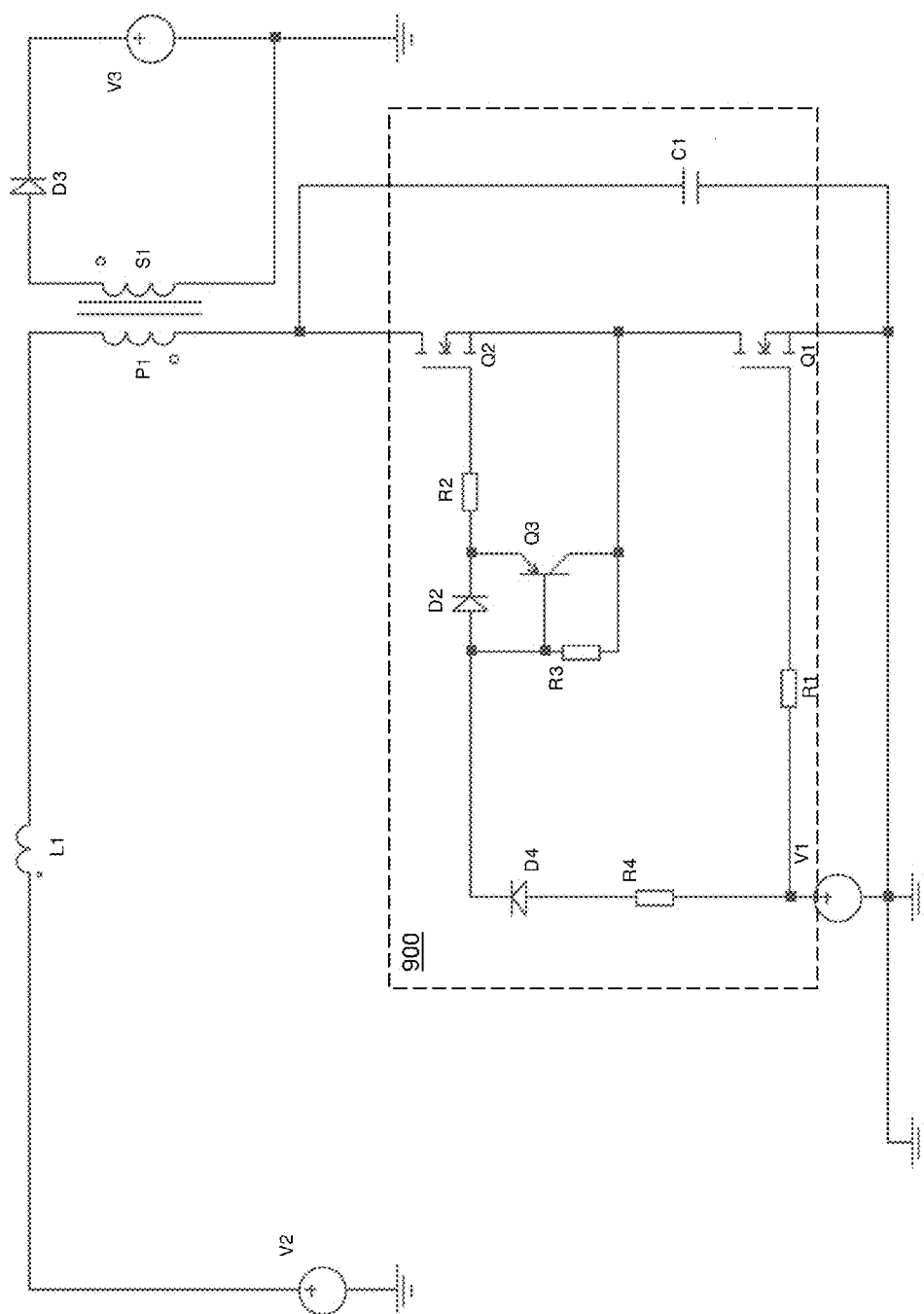


Figure 9

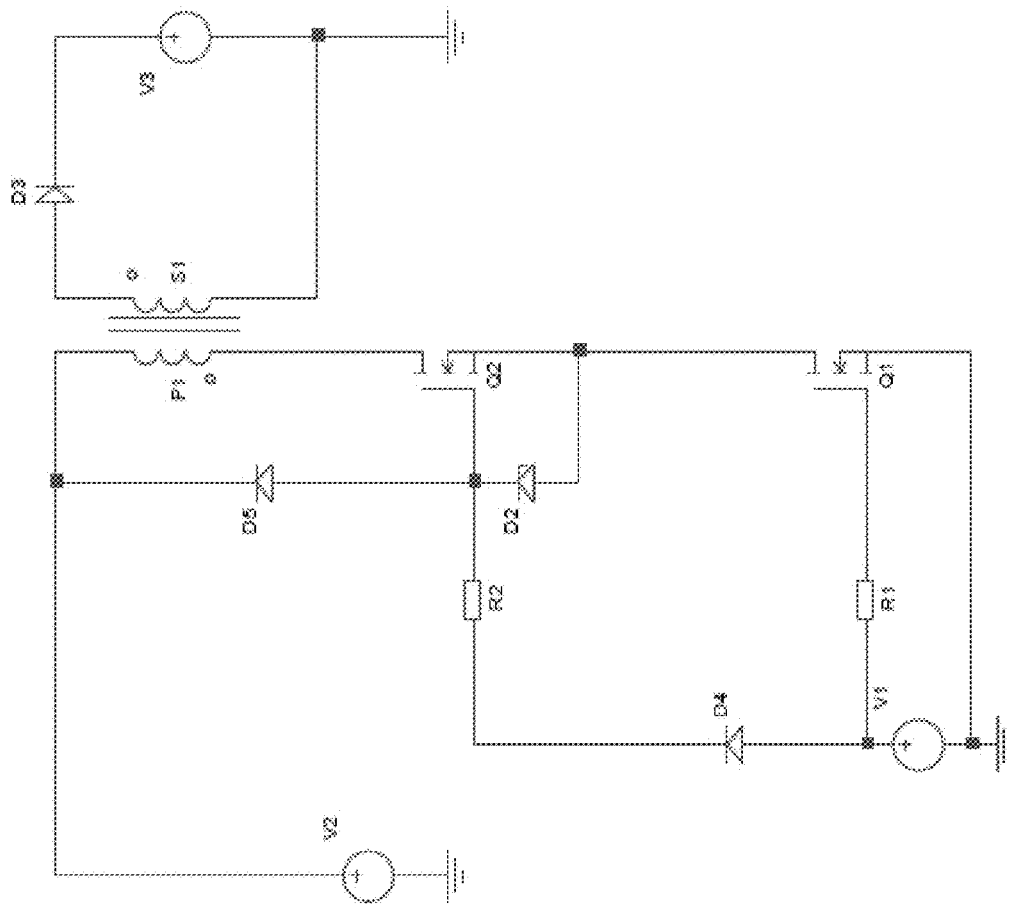


Figure 10

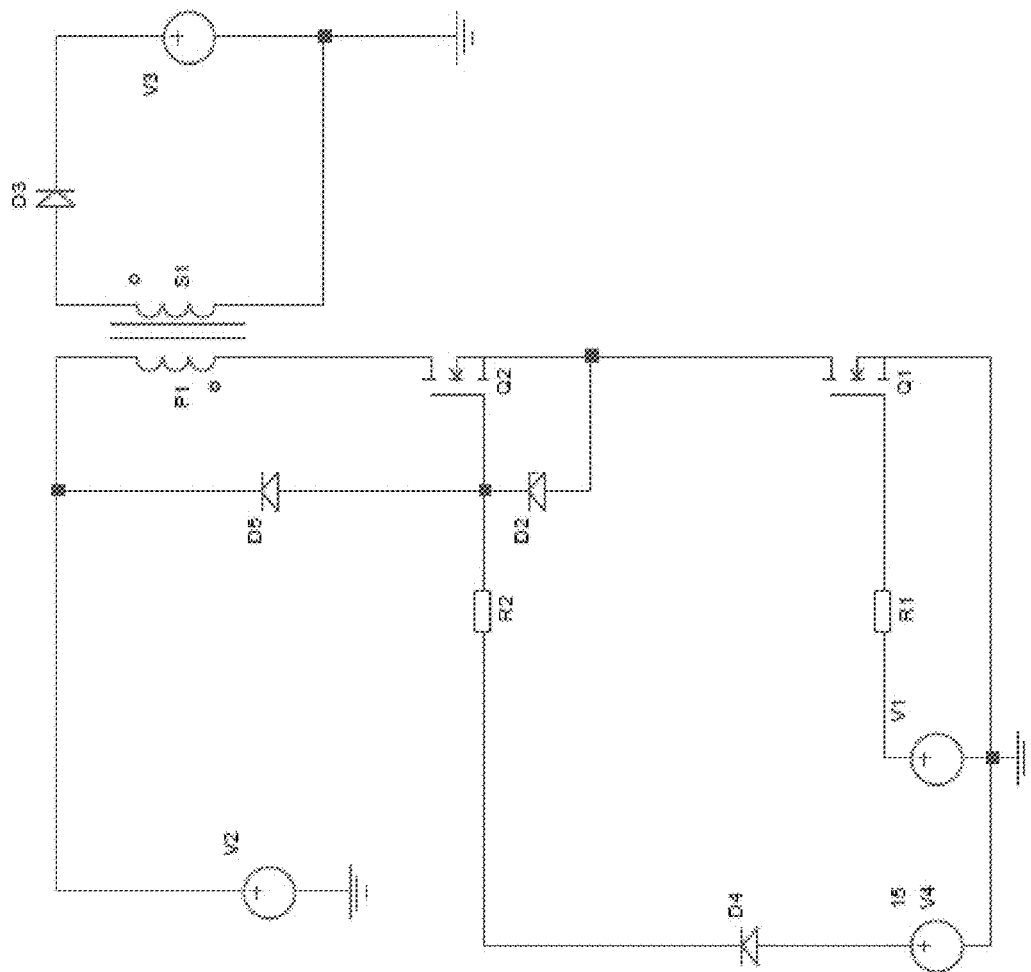


Figure 11

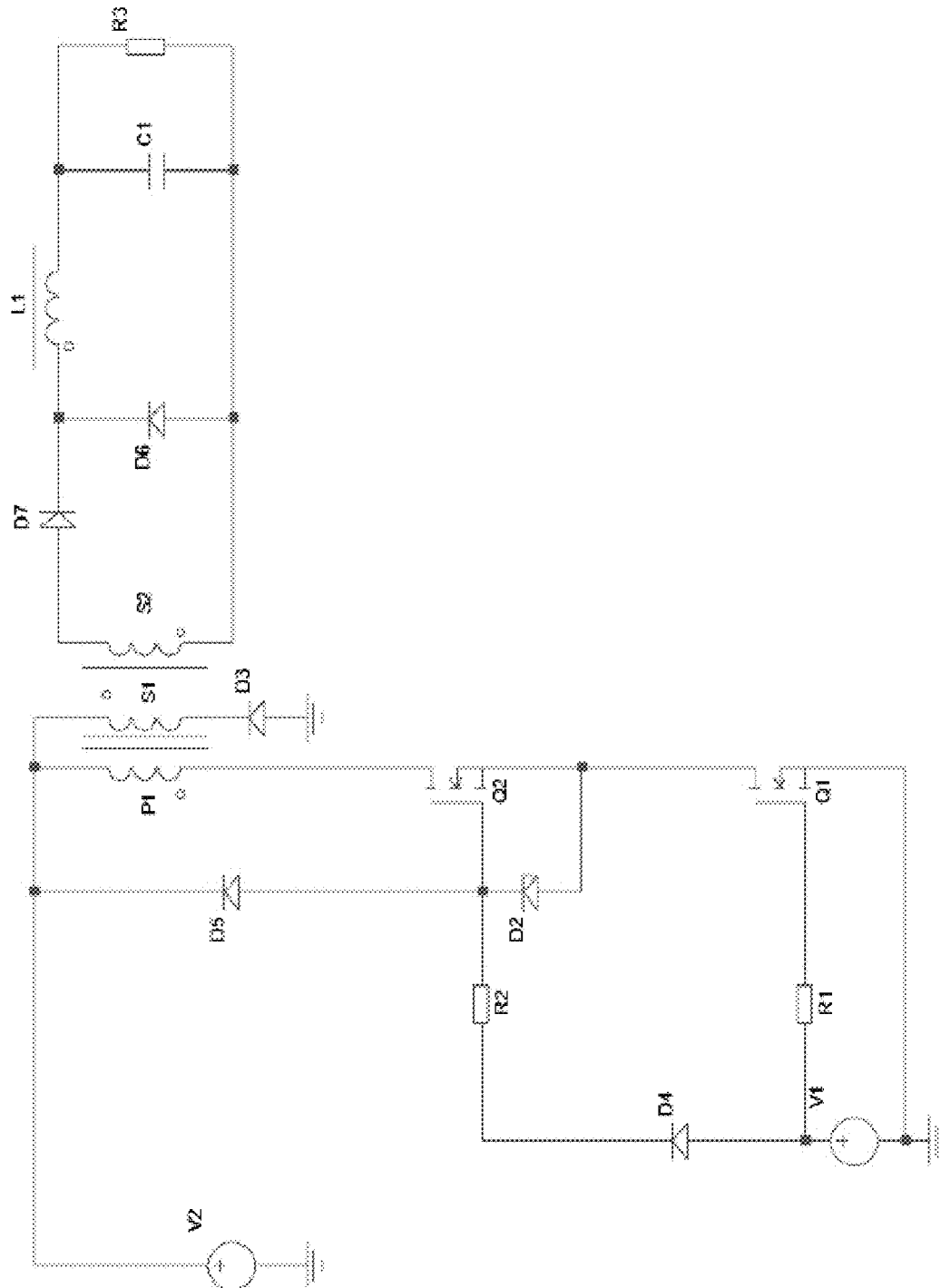


Figure 12

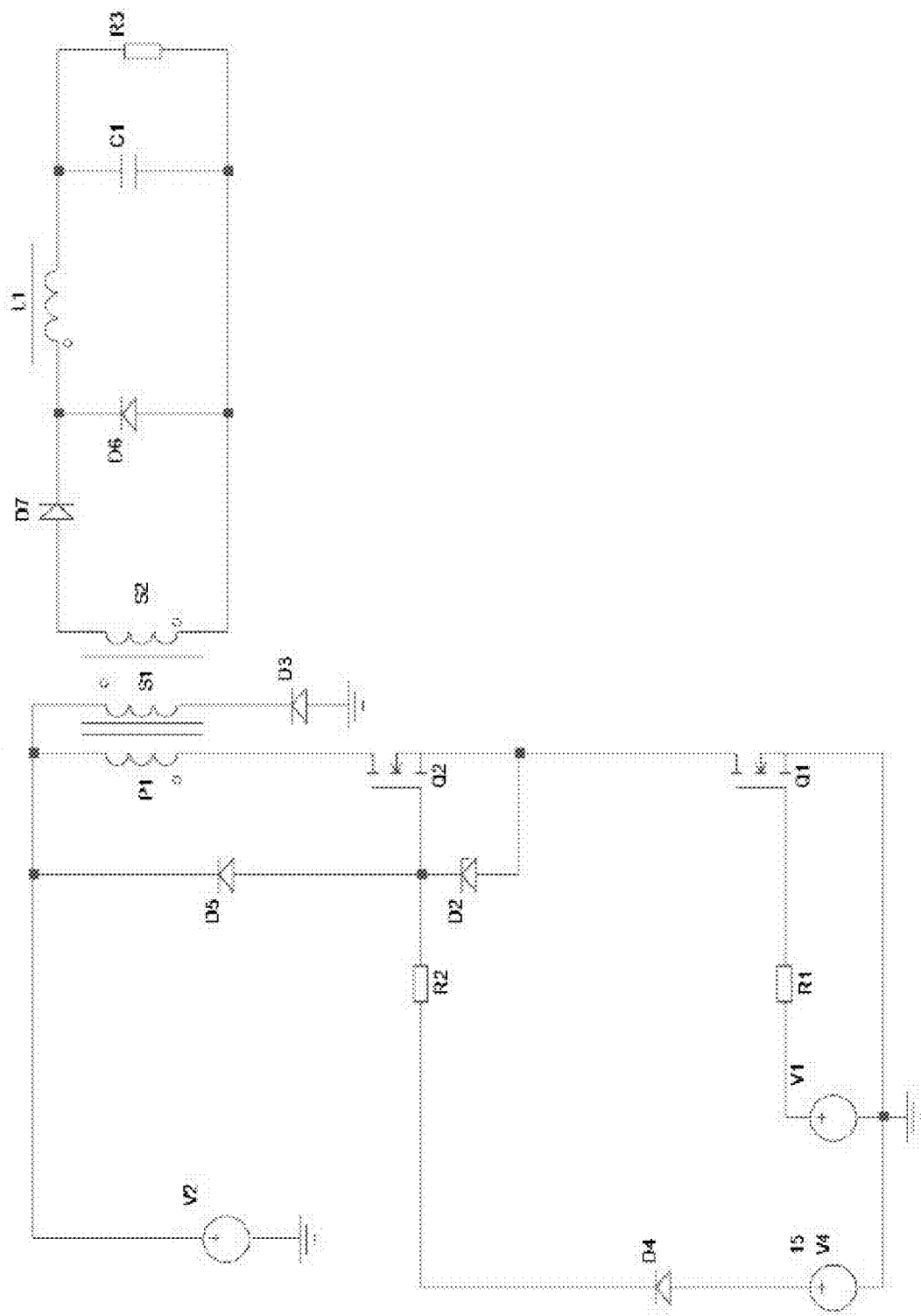


Figure 13

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HALF BRIDGE FLYBACK AND FORWARD**PRIORITY CLAIM**

The present application is a continuation of previously-filed U.S. patent application Ser. No. 13/436,109 filed on Mar. 30, 2012, which in turn is a continuation-in-part of previously-filed U.S. patent application Ser. No. 13/362,100 filed on Jan. 31, 2012, both of said applications incorporated herein by reference in their entirety.

TECHNICAL FIELD

The present application relates to switches, in particular cascode switches.

BACKGROUND

Cascode switches are typically designed with two or more MOSFETs (metal oxide semiconductor field effect transistors) or IGBTs (insulated gate bipolar transistors) connected in series. For example in a two transistor cascode switch, one transistor is coupled to the load and the second transistor is coupled in series between the first transistor and ground. The transistors are switched on and off in order to switch the load current as demanded or required. The load voltage is distributed across all of the series connected power transistors included in the cascode switch. For example, two 800V rated MOSFETs may be connected in series for switching a 1000V or greater load.

A prevalent issue with cascode switches is how to drive the high-side MOSFET or IGBT i.e. the transistor coupled closest to the load. In conventional approaches, a high voltage source such as a Zener diode in series with a resistor is used to turn on the high-side transistor, and the load current flowing through the high-side transistor is used to passively turn off the transistor. The low-side transistor i.e. the transistor coupled closest to ground is switched on and off with a pulsed low voltage source. The disadvantage of this approach is that the passive turn off of the high-side transistor is highly dependent on load current, and during turn off of the high-side transistor there is high dissipation on the low-side transistor voltage limiter.

SUMMARY

Disclosed herein are embodiments in which a low voltage source is used to turn on a high-side transistor of a cascode switch. Other embodiments described herein use a local driver stage to actively turn off the high-side transistor of the cascode switch independent of load current. Various ones of these embodiments may be combined with each other as described herein to yield a cascode switch in which a low voltage source is used to turn on the high-side transistor of the switch and the high-side transistor is actively turned off independent of load current. Further embodiments described herein provide for recovery of a portion of the turn off energy used to turn off of the high-side transistor, avalanche protection and lossless switching.

According to an embodiment of a circuit, the circuit includes a high-side switch, a low-side switch, a diode, a transformer having a primary winding and a secondary winding, and an input connected to a first terminal of the primary winding. The high-side switch has a source, a gate connected to a drive source and a drain connected to a second terminal of the primary winding. The low-side switch has a source connected to ground, a gate connected to a drive

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source and a drain connected to the source of the high-side switch. The diode is connected between the gate of the high-side switch and the first terminal of the primary winding. The diode forms a current loop with the primary winding and the high-side switch to circulate current when low side switch is off until the high side switch turns off.

According to an embodiment of a method of switching a load, the method includes: driving an input connected to a first terminal of a primary winding of a transformer, the transformer having a secondary winding connected to the load; switching on and off a low-side switch having a drain, a source connected to ground, a gate connected to a drive source; switching on and off a high-side switch having a drain connected to a second terminal of the primary winding, a source connected to the drain of the low-side switch and a gate connected to a drive source; and circulating current in a loop formed by the primary winding, the high-side switch and a diode connected between the gate of the high-side switch and the first terminal of the primary winding when the low-side switch is turned off and the high-side switch is turning off.

According to another embodiment of a circuit, the circuit includes a transformer having a primary winding and a secondary winding, an input connected to a first terminal of the primary winding, a high-side switch having a source, a gate connected to a drive source and a drain connected to a second terminal of the primary winding, and a low-side switch having a source connected to ground, a gate connected to a drive source and a drain connected to the source of the high-side switch. A diode is connected between the gate of the high-side switch and the first terminal of the primary winding. The diode is operable to circulate current in a loop with the primary winding and the high-side switch during turning off of the high-side switch and transfer the current to the secondary winding via a magnetic field in the transformer when the primary winding is disconnected after the high-side switch is turned off.

Those skilled in the art will recognize additional features and advantages upon reading the following detailed description, and upon viewing the accompanying drawings.

BRIEF DESCRIPTION OF THE FIGURES

The elements of the drawings are not necessarily to scale relative to each other. Like reference numerals designate corresponding similar parts. The features of the various illustrated embodiments can be combined unless they exclude each other. Embodiments are depicted in the drawings and are detailed in the description which follows.

FIG. 1 illustrates a block diagram of a circuit including a load and a cascode switch coupled to the load, the cascode switch having a high-side power transistor with a low voltage source input.

FIG. 2 illustrates a block diagram of a circuit including a load, a cascode switch coupled to the load and a device for actively turning off a high-side transistor of the cascode switch independent of load current.

FIG. 3 illustrates a block diagram of a circuit including a load and a cascode switch coupled to the load, the cascode switch having a high-side power transistor and a low-side power transistor coupled to the same low voltage source input.

FIG. 4 illustrates a block diagram of a circuit including a load and a cascode switch coupled to the load, the cascode switch having a high-side power transistor and a low-side power transistor coupled to different low voltage source inputs.

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FIG. 5 illustrates a block diagram of a circuit including a load, a cascode switch coupled to the load and an energy recovery device.

FIG. 6 illustrates a block diagram of a circuit including a load, a cascode switch coupled to the load and a bipolar transistor for actively turning off a high-side transistor of the cascode switch independent of load current.

FIG. 7 illustrates a block diagram of a circuit including a load, a cascode switch coupled to the load and bipolar transistors for actively turning off multiple power transistors of the cascode switch independent of load current.

FIG. 8 illustrates a block diagram of a circuit including a load, a cascode switch coupled to the load and voltage limiting circuitry for the cascode switch.

FIG. 9 illustrates a block diagram of a circuit including a load and a cascode switch coupled to the load and having lossless switching.

FIG. 10 illustrates a block diagram of a half bridge flyback circuit.

FIG. 11 illustrates a block diagram of a half bridge flyback circuit according to another embodiment.

FIG. 12 illustrates a block diagram of a half bridge forward converter circuit.

FIG. 13 illustrates a block diagram of a half bridge forward converter circuit according to another embodiment.

DETAILED DESCRIPTION

FIG. 1 illustrates an embodiment of a cascode switch **100** coupled to a load **110**. The load **110** is also connected to an input source **120**. The cascode switch **100** switches the load current, and includes a first power transistor **102** coupled to the load **110** and a second power transistor **104** coupled in series with the first power transistor **102** so that the second power transistor **104** is between ground and the first power transistor **102**. In one embodiment, the cascoded transistors **102**, **104** are power MOSFETs. In another embodiment, the cascoded transistors **102**, **104** are IGBTs. In each case, the second power transistor **104** (also referred to herein as the low-side transistor or switch) switches on and off responsive to a pulse low voltage source **130** coupled to the gate of the low-side transistor **104**.

The first power transistor **102** (also referred to herein as the high-side transistor or switch) switches on and off responsive to the same pulse source as the second power transistor or a DC source **130** coupled to the gate of the high-side transistor **102**. In the first case, both transistors **102**, **104** of the cascode switch **100** are driven from the same pulse source e.g. as provided by a control circuit. In the second case, the low-side transistor **104** is driven from the pulse source and the high-side transistor **102** is driven from a DC supply voltage e.g. also provided by the control circuit. The second scenario where the high-side transistor **102** is driven from a DC supply voltage may be more favorable for high voltage applications e.g. 1000V and above. In either case, a high voltage source is not used to switch on the high-side transistor **102** according to this embodiment. Instead, low voltage turn on drive is used for both the high-side and low-side transistors **102**, **104** of the cascode switch **100**.

FIG. 2 illustrates another embodiment of a cascode switch **200** coupled to a load **110**. The cascode switch **200** has the same series arrangement of power transistors **102**, **104** as in FIG. 1, however the high-side transistor **102** is coupled to a local driver stage **202** which actively turns off the high-side transistor **102** independent of load current. The high-side and low-side power transistors **102**, **104** can each have a low voltage input source **130** as described above with reference to

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FIG. 1, or alternatively the high-side transistor **102** instead may have a high voltage input source. The high-side transistor **102** is actively switched off independent of load current via the local driver stage **202**. The embodiments illustrated in FIGS. 1 and 2 may be combined to yield a cascode switch in which a low voltage source is used to turn on the high-side transistor **102** and the high-side transistor **102** is also actively turned off independent of load current.

FIG. 3 illustrates an embodiment of a cascode switch **300** coupled to a load. The load is transformer according to this embodiment, having a primary winding (P1) and a secondary winding (S1). The primary winding P1 is connected to an input source V2 and the secondary winding S1 is connected to a load represented by voltage V3 via a rectifier diode D3. The cascode switch **300** includes a high-side MOSFET Q2 coupled to the primary winding P1 and a low-side MOSFET Q1 coupled in series between ground and the high-side MOSFET Q1. According to this embodiment, the gate of the low-side MOSFET Q1 is coupled to a pulse low voltage source V1 via a resistor R1. The gate of the high-side MOSFET Q2 is coupled to the same pulse low voltage source V1 as the low-side MOSFET Q1, via a resistor R2 and a rectifier diode D4. The cathode of rectifier diode D4 is connected to resistor R2 and the anode is connected to pulse source V1. Power transistors Q1 and Q2 of the cascode switch **300** are driven from the same low voltage pulse source V1 according to this embodiment.

The cascode switch **300** shown in FIG. 3 further includes a diode D2 which functions as a voltage limiter for maintaining the gate-to-source voltage (Vgs) of the high-side MOSFET Q2 below a safe level e.g. 20V. Usually the amplitude of the pulse low voltage source V1 is lower than this safe level (20V in this example) and therefore voltage limiter diode D2 is provided as a safety measure. The gate of the high-side MOSFET Q2 is also coupled to the anode of rectifier diode D5, the cathode of which is connected to the cathode of transient voltage suppression (TVS) diode D1. The anode of TVS diode D1 is connected to ground. TVS diode D1 functions as a high voltage Zener diode.

During turn on of the cascode switch **300**, pulse source V1 turns on low-side MOSFET Q1 and rectifier diode D4 begins to conduct. In the conducting state rectifier diode D4 charges the input capacitance of high-side MOSFET Q2 through resistor R2, turning on high-side MOSFET Q2.

During turn off of the cascode switch **300**, pulse source V1 turns off low-side MOSFET Q1 which in turn causes the drain-to-source voltage (Vds) of Q1 to begin rising. When Vds of MOSFET Q1 reaches a threshold voltage of TVS diode D1, rectifier diode D5 begins to conduct and load current shifts from the low-side MOSFET Q1 to TVS diode D1. Load current goes through the gate-to-source capacitor Cgs of the high-side MOSFET Q2, discharging Cgs. The high-side MOSFET Q2 turns off when Cgs is discharged. As such, turn off of the high-side MOSFET Q2 depends on the load current according to this embodiment. When Vgs reaches -Vf (forward voltage) of voltage limiter diode D2, current shifts from Cgs to diode D2. Current flows through voltage limiter diode D2 until the high-side MOSFET Q2 completely turns off.

FIG. 4 illustrates an embodiment of a cascode switch **400** which is similar to the embodiment shown in FIG. 3, however the low-side MOSFET Q2 is driven from the pulse source V1 and high-side MOSFET Q1 is driven from a DC source V4. The embodiment shown in FIG. 4 may be more favorable for high voltage applications e.g. 1000V and above.

Described next are additional embodiments of a cascode switch. For ease of illustration, the high-side and low-side

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transistors of the cascode switch are shown connected to the same low voltage pulse source in each of these embodiments. However, the high-side and low-side transistors can be connected to different input sources as described above.

FIG. 5 illustrates an embodiment of a cascode switch **500** which is similar to the embodiment shown in FIG. 3, however the cathode of rectifier diode **D5** is coupled to an energy recovery circuit **510** instead of a TVS diode. The energy recovery circuit **510** includes capacitors **C1** and **C2**, and rectifier diodes **D1**, **D10** and **D11**. The energy recovery circuit **510** stores energy from the load during switching off of the cascode power transistors **Q1** and **Q2**, and reuses the stored energy to power the load during a subsequent switching cycle of the power transistors **Q1** and **Q2**. The circuit shown in FIG. 5 also has a full wave rectifier **520** including diodes **D6**, **D7**, **D8** and **D9** for rectifying AC input source **V2** toward the load.

During turn on of the cascode switch **500**, pulse source **V1** turns on the low-side MOSFET **Q1** and rectifier diode **D4** begins to conduct, charging the input capacitance of the high-side MOSFET **Q2** through resistor **R2**. The high-side MOSFET **Q2** turns on in response. Voltage limiter diode **D2** maintains V_{gs} of the high-side MOSFET **Q2** below a safe level as previously described herein.

During turn off of the cascode switch **500**, pulse source **V1** turns off the low-side MOSFET **Q1** and V_{ds} of **Q1** correspondingly begins to rise. When V_{ds} of the low-side MOSFET **Q1** reaches half of the bus voltage (i.e. half of the voltage across **C1**, **D10**, **C2** or in other words the rectified input voltage), rectifier diode **D5** begins to conduct and load current shifts from the low-side MOSFET **Q1** to the input capacitor **C1** of the energy recovery circuit **510**. Load current also goes through C_{gs} of the high-side MOSFET **Q2**. When C_{gs} of the high-side MOSFET **Q2** is discharged responsive to the load current, the high-side MOSFET **Q2** turns off. When V_{gs} of the high-side MOSFET **Q2** reaches $-V_f$ of the voltage limiter diode **D2**, current shifts from C_{gs} to the voltage limiter diode **D2**. Current flows through diode **D2** until the high-side MOSFET **Q2** completely turns off. Instead of dissipating energy on a TVS diode as is done with the embodiments illustrated in FIGS. 3 and 4, the energy is contained in capacitor **C1** of the energy recovery circuit **510** and reused in the next switching cycle of the cascode switch **500** to improve efficiency. Diodes **D1**, **D10**, **D11** together with capacitors **C1** and **C2** form a passive factor correction circuit which recovers part of the switching energy.

FIG. 6 illustrates another embodiment of a cascode switch **600** which is similar to the embodiment shown in FIG. 3, however an additional device is provided which is coupled to the gate of the high-side MOSFET **Q2** and actively turns off the high-side MOSFET **Q2** independent of load current. According to this embodiment, the device is a bipolar junction transistor (BJT) **Q3** having a base coupled to a node between the cathode of rectifier diode **D4** and the anode of rectifier diode **D2**, an emitter coupled to the gate of the high-side MOSFET **Q2** at a node between the cathode of rectifier diode **D2** and resistor **R2** and a collector coupled to a node between the series connection of the high-side and low-side MOSFETs **Q1** and **Q2**. A resistor **R3** is coupled between the base and collector of BJT **Q3**.

During turn on of the cascode switch **600**, pulse source **V1** turns on the low-side MOSFET **Q1** and rectifier diodes **D2** and **D4** begin to conduct and charge the input capacitance of the high-side MOSFET **Q2** through resistor **R2**. The high-side MOSFET **Q2** turns on in response. BJT **Q3** is off because the base-emitter voltage (V_{be}) of **Q3** is negative.

During turn off of the cascode switch **600**, pulse source **V1** turns off the low-side MOSFET **Q1** and V_{ds} of **Q1** begins to

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rise. This in turn causes diodes **D2** and **D4** to become reverse biased and BJT transistor **Q3** to conduct and discharge C_{gs} of the high-side MOSFET **Q2**, turning off **Q2**. The voltage on both MOSFETs **Q1** and **Q2** rises simultaneously. The turn off time of the high-side MOSFET **Q2** does not depend on the load current according to this embodiment, meaning that there may still be a slight dependence of the turn off time on load current e.g. as in the case of a single MOSFET. The circuit topology does not result in any additional dependency of turn off time on load current.

FIG. 7 illustrates an embodiment of a cascode switch **700** which is similar to the embodiment shown in FIG. 6, however an additional power transistor **Q4** is coupled in series with the first and second power transistors **Q1** and **Q2** so that a voltage applied to the load is distributed across all of the series connected power transistors. An additional BJT **Q5** is also provided in the same configuration as BJT **Q3** for actively turning off power transistor **Q4** independent of the load current. In more detail, BJT **Q5** has a base coupled to a node between the cathode of rectifier diode **D4** and the anode of rectifier diode **D1**, an emitter coupled to the gate of power transistor **Q4** at a node between the cathode of rectifier diode **D1** and resistor **R4** and a collector coupled to a node between the series connection of power transistors **Q4** and **Q2**. Resistor **R5** is coupled between the base and collector of BJT **Q5**.

During turn on of the cascode switch **700**, pulse source **V1** turns on MOSFET **Q1** and rectifier diodes **D5** and **D2** begin to conduct and charge the input capacitance of power transistor **Q2** through resistor **R2**. Transistor **Q2** turns on in response. BJT transistor **Q3** is off because the V_{be} of **Q3** is negative. Rectifier diodes **D4** and **D1** also begin to conduct and charge the input capacitance of power transistor **Q4** through resistor **R4**, and **Q4** turns on in response. BJT transistor **Q5** is also off because the V_{be} of **Q5** is negative.

During turn off of the cascode switch **700**, pulse source **V1** turns off MOSFET **Q1** and V_{ds} of **Q1** starts to rise. This in turn causes rectifier diodes **D2** and **D5** to become reverse biased, and BJT transistor **Q3** to conduct and discharge the C_{gs} of MOSFET **Q2**. Transistor **Q2** turns off in response. Similarly, rectifier diodes **D1** and **D4** become reverse biased and BJT transistor **Q5** conducts and discharges the C_{gs} of MOSFET **Q4**, and **Q4** turns off. The voltage rises on all three MOSFETs **Q1**, **Q2** and **Q4** simultaneously. As with the embodiment illustrated in FIG. 6 the turn off time of MOSFETs **Q1**, **Q2** and **Q4** does not depend on load current according to this embodiment, meaning that there may still be a slight dependence of the turn off time on load current e.g. like for a single MOSFET. Also, the circuit topology does not result in any additional dependency of turn off time on load current.

During turn off and because of component tolerances, one of the power transistors included in a cascode switch can achieve maximum voltage before the other one(s). This transistor enters avalanche mode until the other power transistor turns off. The duration of avalanche is very small e.g. less than 20 ns, and avalanche energy dissipated on the power transistor is typically well below the avalanche energy of the transistor. However if the power transistor does not have avalanche capability, a voltage limiter can be introduced.

FIG. 8 illustrates an embodiment of a cascode switch **800** which is similar to the embodiment shown in FIG. 6, with the addition of voltage limiter circuitry. According to one embodiment, a first voltage limiter includes rectifier diode **D6** and TVS diode **D1** connected in parallel with MOSFET **Q1**. A second voltage limiter includes rectifier diode **D7** and TVS diode **D8** connected in parallel with MOSFET **Q2**. TVS diodes **D1** and **D8** function as high voltage Zener diodes to

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protect MOSFET Q1 and Q2, respectively. The first and second voltage limiters protect MOSFETs Q1 and Q2 by preventing or at least minimizing avalanche conditions. According to another embodiment, rectifier diode D5 is provided instead of diodes D6, D1, D7 and D8. Rectifier diode D5 has a cathode coupled to the load source V2 and an anode coupled to the source of low-side MOSFET Q1, and protects Q1 from avalanche conditions. In this case, the low-side MOSFET Q1 sustains the input voltage and the high-side MOSFET Q2 sustains the transformer reflected voltage and spikes caused by leakage inductance.

Further enhancements can be made to the cascode switches previously described herein. For example, lossless switching may be provided by ensuring the transformer reflected voltage is equal to the load input voltage and the cascode switch is turned on when the voltage equals or is close to zero.

FIG. 9 illustrates an embodiment of a cascode switch 900 which is similar to the embodiment shown in FIG. 6. Compared to FIG. 6, the cascode switch 900 shown in FIG. 9 has an additional capacitor C1 coupled in parallel with the series connected power MOSFETs Q1 and Q2 and a resistor R4 which couples pulse voltage source V1 to the anode of rectifier diode D4. Resistor R4 enables asymmetric switching of the cascode switch 900 i.e. different turn on and off periods. When MOSFETs Q1 and Q2 turn off, current moves from MOSFETs Q1 and Q2 to capacitor C1. The load current charges capacitor C1, and there are no losses on the cascode switch 900 because capacitor C1 is charged by the load current until the voltage reaches a certain value, when secondary diode D3 begins to conduct. When all energy from the transformer (P1/S1) is released to the secondary winding S1, diode D3 stops conducting and begins to oscillate between the switch capacitance (MOSFETs+C1) and the transformer inductance. When the voltage on the cascode switch 900 reaches zero, the switch 900 turns on and the turn off energy stored in capacitor C1 discharges to the load input source V2.

FIG. 10 illustrates an embodiment of a half bridge fly back circuit which is similar to the embodiment shown in FIG. 3, however diode D5 is connected between the gate of the high-side switch Q2 and the terminal of the primary winding P1 connected to the input source V2. According to this embodiment, diode D5 forms a current circulation loop with the primary winding P1 and the high-side switch Q2 during switching off of the high-side switch Q2.

In more detail, the high-side switch Q2 has a source, a gate connected to pulsed drive source V1 through resistor R2 and diode D4, and a drain connected to a second terminal of the primary winding P1. The low-side switch Q1 has a source connected to ground, a gate connected to pulsed drive source V1 through resistor R1 and a drain connected to the source of the high-side switch Q2. The anode of diode D5 is connected to the gate of the high-side switch Q2 and the cathode of diode D5 is connected to the input terminal of the primary winding P1.

Diode D5, the primary winding P1 and the high-side switch Q2 form a current loop when the low-side switch Q1 is turned off and the high-side switch Q2 is in the process of turning off. The current circulated in this loop is transferred to the secondary winding S1 of the transformer after the high-side switch Q2 is switched off, conserving energy and increasing efficiency of the circuit. To this end, the anode of diode D3 is connected to a terminal of the secondary winding S1 and the cathode of diode D3 is connected to the load. The load is represented by voltage V3 in FIG. 10. Diode D5 transfers current from the loop to the secondary winding S1 via the magnetic field in the transformer when the primary winding P1 is disconnected after the high-side switch is turned off and

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diode D3 is forward biased. Diode D3 becomes forward biased when the high-side switch Q2 turns off. The high-side switch Q2 turns off and diode D3 becomes forward biased when current flowing in the loop discharges the gate-to-source capacitance (C_{GS}) of the high-side switch Q2.

Current in the loop formed by diode D5, the primary winding P1 and the high-side switch Q2 goes through the gate-to-source capacitance C_{GS} of the high-side switch Q2. The current loop is formed when diode D5 is forward biased and the high-side switch Q2 is turning off. Diode D5 forward biases when the drain-to-source voltage (V_{DS}) of the high-side switch Q2 rises above a voltage level at the half bridge input (V2). The drain-to-source voltage V_{DS} of the high-side switch Q2 rises above the voltage level at the input a period of time after the low-side switch Q1 begins to turn off. Low-side switch Q1 begins to turn off when pulsed source V1 deactivates. This in turn causes the drain-to-source voltage V_{DS} of the low-side switch Q1 to begin rising. When V_{DS} of the low-side switch Q1 reaches the input voltage V2, diode D5 begins to conduct and load current shifts from the low-side switch Q1 to diode D5. Energy is preserved in the current loop formed by diode D5, the primary winding P1 and the high-side switch Q2 when diode D5 is conducting and C_{GS} of the high-side switch Q2 is discharging.

Voltage limiter diode D2 maintains the current loop after C_{GS} of the high-side switch Q2 is fully discharged and Q2 turns off. Turn off of the high-side switch Q2 depends on the load current according to this embodiment. When the gate-to-source voltage (V_{GS}) of the high-side switch Q2 reaches the forward voltage of voltage limiter diode D2, current shifts from C_{GS} of the high-side switch Q2 to diode D2. Current flows through voltage limiter diode D2 until the high-side switch Q2 completely turns off. When high-side switch Q2 turns off, the drain-to-source voltage (V_{DS}) of Q2 rises until the voltage on the secondary winding S1 becomes equal to V3 and diode D3 begins to conduct, transferring energy from the primary side of the transformer to the secondary side.

FIG. 11 illustrates an embodiment of a half bridge fly back circuit which is similar to the embodiment shown in FIG. 10, however the gate of the high-side switch Q2 and the gate of the low-side switch Q1 are connected to different drive sources. In the embodiment shown in FIG. 10, both switch gates are connected to the same pulsed voltage drive source V1. Particularly, the high-side switch Q2 is connected to the pulsed voltage drive source V1 through resistor R2 and diode D4 and the low-side switch Q1 is connected to the pulsed voltage drive source V1 through resistor R1. This way, the gates of both switches Q1, Q2 are externally accessible through the same pin i.e. the pin provided for the pulsed voltage drive source V1.

In contrast, FIG. 11 shows the gate of the high-side switch Q2 and the gate of the low-side switch Q1 connected to different drive sources. Particularly, the gate of the high-side switch Q2 is connected to a DC voltage drive source V4 through resistor R2 and diode D4. The DC voltage drive source V4 can be an internal V_{CC} supply for the circuit, and therefore the gate of the high-side switch Q2 is not externally accessible. The gate of the low-side switch is connected to the pulsed voltage drive source V1 through resistor R1. The pulsed voltage source V1 is an external source for which a pin is provided, and therefore the gate of the low-side switch Q1 is externally accessible through this pin. For example, the low-side switch Q1 may be fabricated on a separate semiconductor die than the high-side switch Q2. In this case, the gate of the low-side switch Q1 is externally accessible via the pin used for the pulsed voltage drive source input. The gate of the high-side switch Q2 is powered by an internal DC supply

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voltage V4 according to this embodiment, and therefore not externally accessible via a pin.

FIG. 12 illustrates an embodiment of a half bridge forward converter circuit. The half bridge forward converter passes energy directly to the output of the forward converter by transformer action during the switch conduction phase. During turn on of the half bridge switch i.e. Q1 and Q2 are conducting, there are two parallel processes. In one process, diode D7 is directly biased (conducting) and current goes from input voltage source V2 through the transformer (primary P1 and secondary S2 are active) and inductor L1 to the load which is represented by the parallel combination of resistor R3 and capacitor C1. In the second process, the primary side of the transformer is exposed to the input voltage source V2. During the turn on period, magnetizing current rises from zero to a value I_m .

During turn off when Q1 and Q2 turn off, the following processes occur. The pulse source output goes to zero, causing the low-side switch Q1 to turn off. This in turn causes the drain-to-source voltage (V_{DS}) of Q1 to rise. When V_{DS} of Q1 achieves a particular level of the input voltage input, current divides into two parts: a load current path (going through L1) and a magnetizing current path (going through D5).

In the load current path, diode D7 becomes reverse biased and eventually turns off. This in turn causes diode D6 to begin conducting and continues to carry inductor L1 current. In the magnetizing current path, diode D5 begins to conduct and magnetizing current discharges the gate-to-source capacitance (C_{GS}) of the high-side switch Q2, turning off Q2. When the high-side switch Q2 is off, voltage rises to the level of input voltage V2 (e.g. if the number of turns for P1 and S1 are the same, or $V2 \cdot N_{S1}/N_{P1}$), then diode D3 begins to conduct returning magnetizing current back to the input voltage source V2.

FIG. 13 illustrates an embodiment of a half bridge forward converter circuit which is similar to the embodiment shown in FIG. 12, however the gate of the high-side switch Q2 and the gate of the low-side switch Q1 are connected to different drive sources V4, V1 as previously described herein e.g. with reference to FIG. 11.

Terms such as “first”, “second”, and the like, are used to describe various elements, regions, sections, etc. and are not intended to be limiting. Like terms refer to like elements throughout the description.

As used herein, the terms “having”, “containing”, “including”, “comprising” and the like are open ended terms that indicate the presence of stated elements or features, but do not preclude additional elements or features. The articles “a”, “an” and “the” are intended to include the plural as well as the singular, unless the context clearly indicates otherwise.

It is to be understood that the features of the various embodiments described herein may be combined with each other, unless specifically noted otherwise.

Although specific embodiments have been illustrated and described herein, it will be appreciated by those of ordinary skill in the art that a variety of alternate and/or equivalent implementations may be substituted for the specific embodiments shown and described without departing from the scope of the present invention. This application is intended to cover any adaptations or variations of the specific embodiments discussed herein. Therefore, it is intended that this invention be limited only by the claims and the equivalents thereof.

What is claimed is:

1. A circuit, comprising:
a transformer having a first winding and a second winding;
an input connected to a first terminal of the first winding;

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a first power transistor having a source, a gate connected to a DC source, and a drain connected to a second terminal of the first winding; and

a second power transistor having a source connected to ground, a gate connected to a pulsed voltage drive source, and a drain connected to the source of the first power transistor,

wherein the first power transistor actively turns off independent of load current.

2. The circuit of claim 1, wherein a current loop including the first winding and the first power transistor forms when the second power transistor is turned off and the first power transistor is turning off.

3. The circuit of claim 2, wherein current transfers from the loop to the second winding via a magnetic field in the transformer when the first winding is disconnected after the first power transistor is turned off.

4. The circuit of claim 3, wherein the first power transistor turns off responsive to the current flowing in the loop discharging a gate-to-source capacitance of the first power transistor.

5. A method of switching a load, comprising:

driving an input connected to a first terminal of a first winding of a transformer, the transformer having a second winding connected to the load;

connecting a drain of a first power transistor to a second terminal of the first winding, the first power transistor also having a source and a gate;

connecting a drain of a second power transistor to the source of the first power transistor, the second power transistor also having a source connected to ground and a gate;

connecting the gate of the first power transistor to a DC source and the gate of the second power transistor to a pulsed voltage drive source; and

circulating current in a loop including by the first winding and the first power transistor when the second power transistor is turned off and the first power transistor is turning off.

6. The method of claim 5, further comprising transferring current from the loop to the second winding via a magnetic field in the transformer when the first winding is disconnected after the first power transistor is turned off.

7. The method of claim 6, further comprising turning off the first power transistor responsive to a gate-to-source capacitance of the first power transistor being discharged by the current flowing in the loop.

8. The method of claim 5, further comprising maintaining the current loop responsive to a gate-to-source capacitance of the first power transistor discharging.

9. A circuit, comprising:

a transformer having a first winding and a second winding;
an input connected to a first terminal of the first winding;
a first power transistor having a source, a gate connected to a DC voltage drive source, and a drain connected to a second terminal of the first winding;

a second power transistor having a source connected to ground, a gate connected to a pulsed voltage drive source, and a drain connected to the source of the first power transistor; and

a loop configured to circulate current with the first winding and the first power transistor during turning off of the first power transistor, and transfer the current to the second winding via a magnetic field in the transformer when the first winding is disconnected after the first power transistor is turned off.

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10. The circuit of claim **9**, wherein current is transferred from the loop to the second winding via the magnetic field in the transformer when the first winding is disconnected after the first power transistor is turned off.

11. The circuit of claim **10**, wherein the first power transistor is operable to turn off responsive to the current flowing in the loop discharging a gate-to-source capacitance of the first power transistor. 5

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UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 9,281,813 B2
APPLICATION NO. : 14/150081
DATED : March 8, 2016
INVENTOR(S) : M. Ivankovic

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page item (73), Assignee, please change “Infineon Technologies AG, Neubiberg (DE)” to
-- Infineon Technologies Austria AG, Villach (AT) --

Signed and Sealed this
Eighth Day of November, 2016

A handwritten signature in black ink, reading "Michelle K. Lee". The signature is fluid and cursive, with the first letters of each name being capitalized and prominent.

Michelle K. Lee
Director of the United States Patent and Trademark Office